© Copyright 2005. I	© Convright 2005 IPC Bannockhurn Illinois All rights reserved under both				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
			Form Type Distribute	e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia				erials and I	als and Mfg Information					
Supplier Information														
Company name*	Company uni	Company unique ID			Unique ID Authority				Respo	Response Date*				
nsemi										2025-0	2025-07-31			
ntact Name Title - Contact			et			Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards Product E			duct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Rep			- Representative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Iter	n Number	Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
	MT9M CR1	AT9M114EBLSTCZ- 1 MP 1/6 SOC CIS CR1		IS		2025-07-31					27.085	mg	Each	
Ianufacturing Proccess Informa	tion													
Terminal Plating / Grid Array M	Terminal Plating / Grid Array Material Terminal Base Alloy			J-STD-020 MSL	TD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperat					ature Num	ber of Reflow Cyd	cles		
SnAgCu CU Alloy		CU Alloy	3			260 C		С	30 seco		seconds 3			
omments														
TTENTION: MSL 3 Rated item require	s Bake and I	Dry Pack (after	electrical test)											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.09	mg		Misc.	proprietary data		0.0155	mg
			Supplier	Silicon (Si)	7440-21-3		4.034	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0405	mg
Die Attach	0.57	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.342	mg
			Supplier	Epoxy resins	129915-35-1		0.114	mg
			Supplier	Acrylic resins	Proprietary Data		0.114	mg
Electrode	0.45	mg	Supplier	Titanium (Ti)	7440-32-6		0.0003	mg
			В	Nickel (Ni)	7440-02-0		0.2679	mg
			Supplier	Gold (Au)	7440-57-5		0.0108	mg
			Supplier	Copper (Cu)	7440-50-8		0.0067	mg
			Supplier	Aluminum (Al)	7429-90-5		0.1643	mg
Glass Lid /Cap	19.46	mg	Supplier	Boron Trioxide (B2O3)	1303-86-2		2.7633	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		9.73	mg
			Supplier	Barium Monoxide (BaO)	1304-28-5		4.6704	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		2.1406	mg
			Supplier	Calcium Monoxide (CaO)	1305-78-8		0.0195	mg
			В	Arsenic Trioxide (As2O3)	1327-53-3		0.1362	mg
Lid Attach	0.005	mg		Photoinitiator	proprietary data		0.0012	mg
			Supplier	Epoxy Prepolymer	Proprietary Data		0.0037	mg
Passivation	0.33	mg	Supplier	Pentaerythritol triacrylate	3524-68-3		0.0495	mg
			Supplier	2-(2-methoxypropoxy)propanol	34590-94-8		0.033	mg
			Supplier	Epoxy Phenol Novolak Resin	28064-14-4		0.033	mg
			Supplier	9-Phenylacridine	602-56-2		0.0165	mg
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.198	mg
Solder Ball	0.42	mg	Supplier	Silver (Ag)	7440-22-4		0.0126	mg
			Supplier	Tin (Sn)	7440-31-5		0.4053	mg
			Supplier	Copper (Cu)	7440-50-8		0.0021	mg
Substrate and Solder Mask	1.76	mg	Supplier	Silica crystalline	14808-60-7, 14464- 46-1		0.176	mg
			Supplier	Cured Resin of Solder Mask	Proprietary Data		0.836	mg
			Supplier	Bismaleimide Triazine resin	Proprietary Data		0.748	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).